

SL 5.08HC/20/180F 4.5SN LTGY BX

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image



Similar to illustration

Pin headers in glass-fibre-reinforced plastic with straight wire outlet; optimised for wave soldering. The flange variant (F) can be screwed onto the respective counter piece or the circuit board. There is no need for an extra screw to connect the circuit board when the solder flange (LF) version is used. This also protects the solder points from mechanical strain. All pin headers can be manually coded or ordered pre-coded. HC = High Current.

General ordering data

Version	PCB plug-in connector, male header, Flange, THT/THR solder connection, 5.08 mm, Number of poles: 20, 180°, Solder pin length (l): 4.5 mm, tinned, grey, Box
Order No.	1981360000
Type	SL 5.08HC/20/180F 4.5SN LTGY BX
GTIN (EAN)	4032248676644
Qty.	12 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Box

Creation date April 15, 2021 6:59:13 PM CEST

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Technical data

Dimensions and weights

Depth	8.5 mm	Depth (inches)	0.335 inch
Height	16.5 mm	Height (inches)	0.65 inch
Height of lowest version	12 mm	Net weight	7.91 g
Width	111.6 mm	Width (inches)	4.394 inch

System specifications

Product family	OMNIMATE Signal - series BL/SL 5.08		
Type of connection	Board connection		
Mounting onto the PCB	THT/THR solder connection		
Pitch in mm (P)	5.08 mm		
Pitch in inches (P)	0.2 inch		
Outgoing elbow	180°		
Number of poles	20		
Number of solder pins per pole	1		
Solder pin length (l)	4.5 mm		
Solder pin length tolerance	0 / -0.3 mm		
Solder pin dimensions	d = 1.2 mm, Octagonal		
L1 in mm	96.52 mm		
L1 in inches	3.8 inch		
Pin series quantity	1		
Volume resistance	≤5 mΩ		
Can be coded	Yes		
Plugging force/pole, max.	9 N		
Pulling force/pole, max.	7 N		
Tightening torque	Torque type	Mounting screw, PCB	
	Usage information	Tightening torque	min. 0.15 Nm
			max. 0.2 Nm
		Recommended screw	Part number PTSC KA 2.2X4.5 WN1412

Material data

Insulating material	LCP GF	Colour	grey
Colour chart (similar)	RAL 7035	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuMg
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 2...4 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

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Technical data

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	27.5 A
Rated current, max. number of poles (Tu=20°C)	19 A	Rated current, min. number of poles (Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		

Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	200039-1176845
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group D / CSA)	18.5 A	Reference to approval values	Specifications are maximum values, details - see approval certificate.

Rated data acc. to UL 1059

Institute (UR)		Certificate No. (UR)	E60693
Institute (cURus)		Certificate No. (cURus)	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	18.5 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Packing

Packaging	Box	VPE length	35 mm
VPE width	130 mm	VPE height	150 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

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Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• Gold-plated contact surfaces on request • Rated current related to rated cross-section & min. No. of poles. • Diameter of solder eyelet $D = 1.4 + 0.1 \text{ mm}$ • Solder eyelet diameter $D = 1.5 + 0.1 \text{ mm}$, from 9 poles • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Approvals

Approvals



ROHS	Conform
UL File Number Search	E60693

Downloads

Approval/Certificate/Document of Conformity	CB Certificate CB Testreport
Brochure/Catalogue	Catalogues in PDF-format

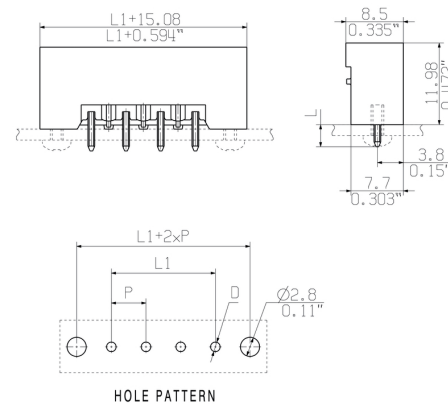
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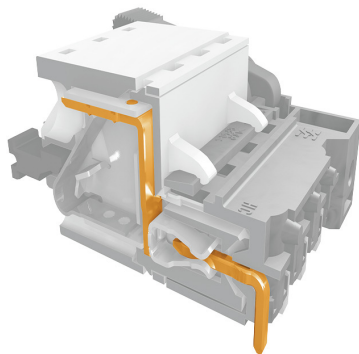
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Drawings

Dimensional drawing



Product benefits



Safe power transmission
Proven properties

Graph



Graph



Graph



Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.